



ALPHA & OMEGA
SEMICONDUCTOR

AON3702

30V N-Channel MOSFET

SRFET™

General Description

SRFET™ AON3702 uses advanced trench technology with a monolithically integrated Schottky diode to provide excellent $R_{DS(ON)}$ and low gate charge. This device is suitable for use as a low side FET in SMPS, load switching and general purpose applications.

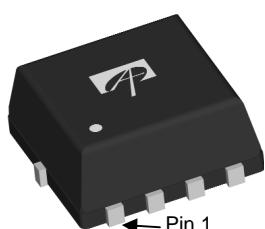
Product Summary

V_{DS} (V) = 30V
 I_D = 11A (V_{GS} = 10V)
 $R_{DS(ON)} < 14.5\text{m}\Omega$ (V_{GS} = 10V)
 $R_{DS(ON)} < 18\text{m}\Omega$ (V_{GS} = 4.5V)

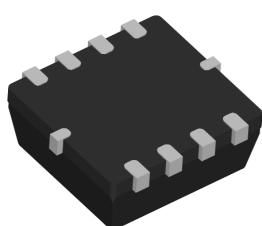
100% R_g Tested



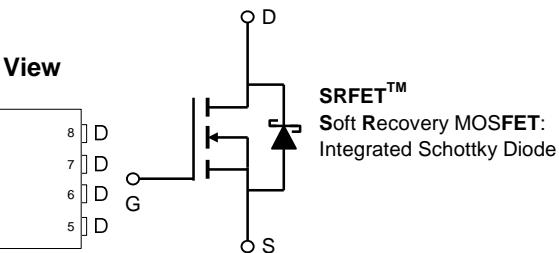
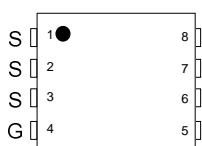
Top View



Bottom View



Top View



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current ^A	I_{DSM}	11	A
	I_{DSM}	9	
Pulsed Drain Current ^B	I_{DM}	60	
Power Dissipation ^C	P_{DSM}	3.1	W
	P_{DSM}	2	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	30	40	°C/W
Maximum Junction-to-Ambient ^A		65	80	°C/W
Maximum Junction-to-Lead ^C	$R_{\theta JL}$	20	25	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{\text{GS}}=0\text{V}$	30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=24\text{V}, V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$		0.01	0.1	mA
I_{GSS}	Gate-Body leakage current	$V_{\text{DS}}=0\text{V}, V_{\text{GS}}= \pm 12\text{V}$		4	10	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_D=250\mu\text{A}$	1.5	1.9	2.4	V
$I_{\text{D(ON)}}$	On state drain current	$V_{\text{GS}}=4.5\text{V}, V_{\text{DS}}=5\text{V}$	60			A
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}, I_D=11\text{A}$ $T_J=125^\circ\text{C}$		12	14.5	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_D=10\text{A}$		19	24	$\text{m}\Omega$
g_{FS}	Forward Transconductance	$V_{\text{DS}}=5\text{V}, I_D=11\text{A}$		64		S
V_{SD}	Diode Forward Voltage	$I_S=1\text{A}, V_{\text{GS}}=0\text{V}$		0.38	0.5	V
I_S	Maximum Body-Diode + Schottky Continuous Current				5.0	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=15\text{V}, f=1\text{MHz}$		1450	1885	pF
C_{oss}	Output Capacitance			224		pF
C_{rss}	Reverse Transfer Capacitance			92		pF
R_g	Gate resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, f=1\text{MHz}$		1.6	3.0	Ω
SWITCHING PARAMETERS						
$Q_g(10\text{V})$	Total Gate Charge	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=15\text{V}, I_D=11\text{A}$		24.0	31	
$Q_g(4.5\text{V})$	Total Gate Charge			12.0		nC
Q_{gs}	Gate Source Charge			3.9		nC
Q_{gd}	Gate Drain Charge			4.2		nC
$t_{\text{D(on)}}$	Turn-On DelayTime	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=15\text{V}, R_L=1.4\Omega, R_{\text{GEN}}=3\Omega$		5.5		ns
t_r	Turn-On Rise Time			4.7		ns
$t_{\text{D(off)}}$	Turn-Off DelayTime			24.0		ns
t_f	Turn-Off Fall Time			4.0		ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=11\text{A}, dI/dt=300\text{A}/\mu\text{s}$		10	12	ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=11\text{A}, dI/dt=300\text{A}/\mu\text{s}$		6.8		nC

A: The value of $R_{\theta JA}$ is measured with the device in a still air environment with $T_A=25^\circ\text{C}$. The power dissipation P_{DSM} and current rating I_{DSM} are based on $T_{J(\text{MAX})}=150^\circ\text{C}$, using $t \leq 10\text{s}$ junction-to-ambient thermal resistance.

B: Repetitive rating, pulse width limited by junction temperature $T_{J(\text{MAX})}=150^\circ\text{C}$.

C. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to lead $R_{\theta JL}$ and lead to ambient.

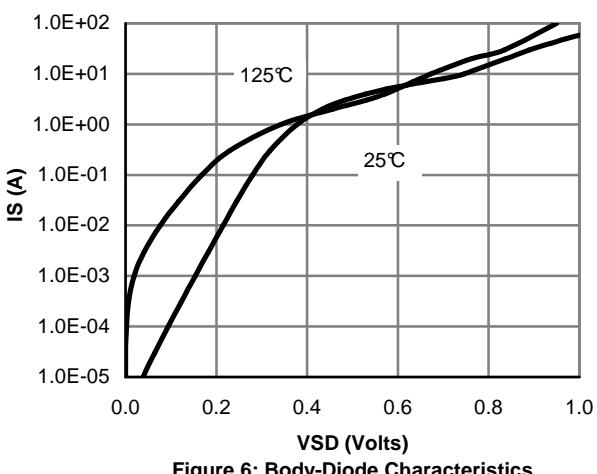
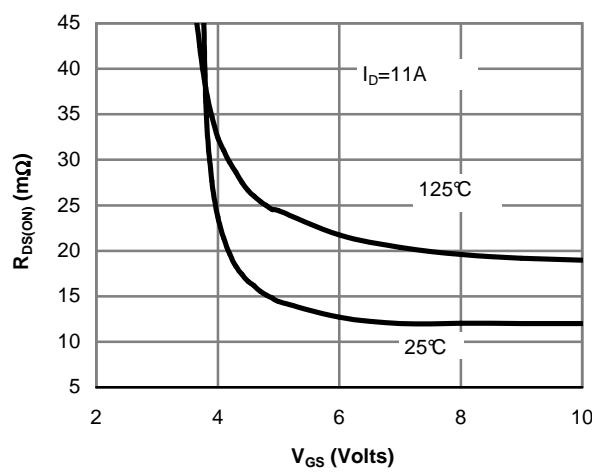
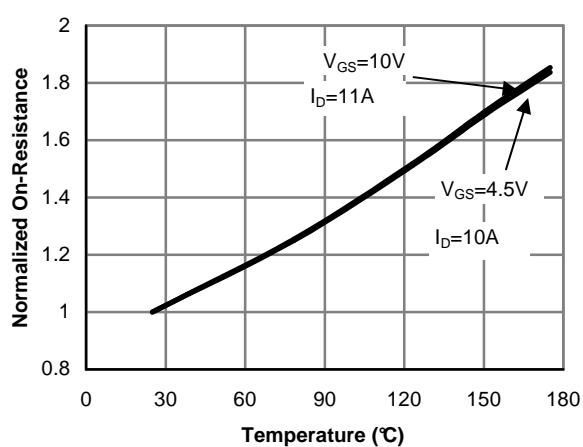
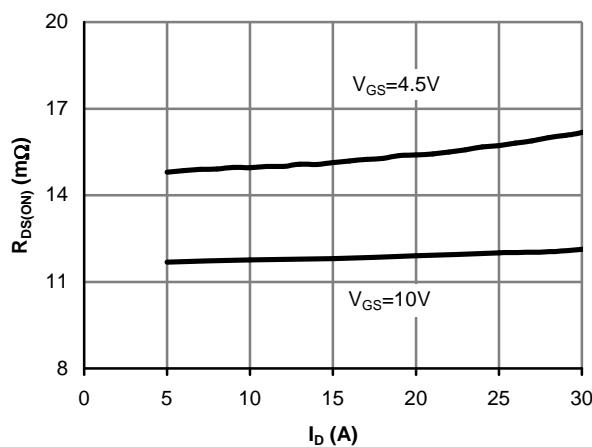
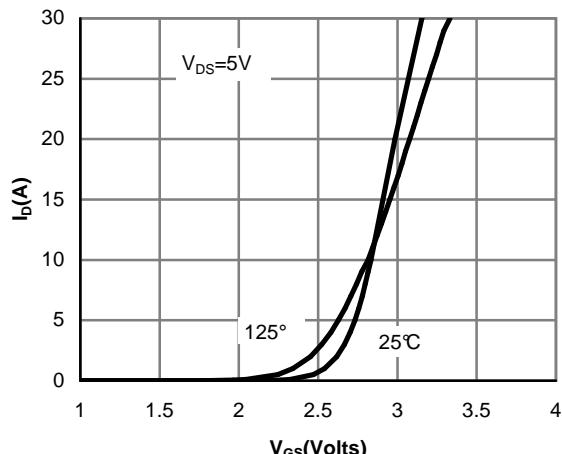
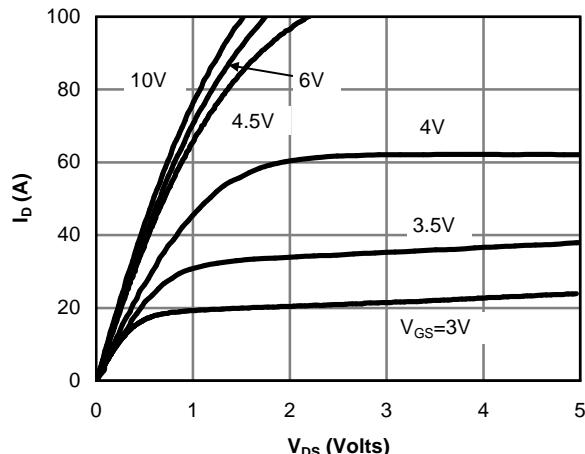
D. The static characteristics in Figures 1 to 6 are obtained using $<300\text{ }\mu\text{s}$ pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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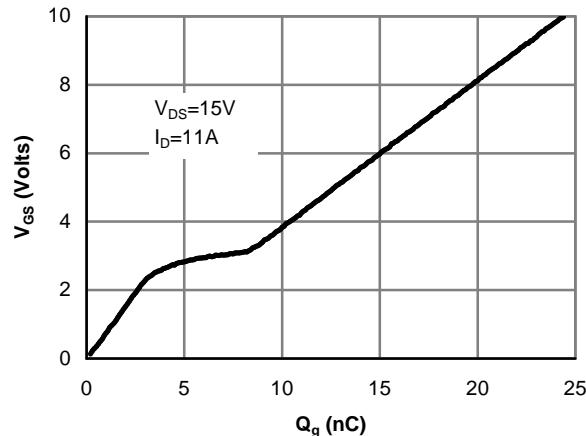


Figure 7: Gate-Charge Characteristics

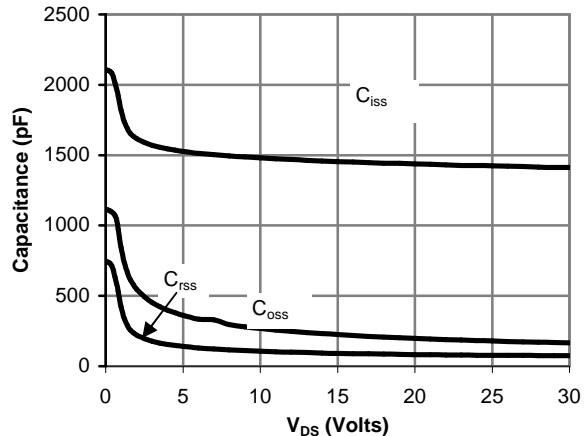


Figure 8: Capacitance Characteristics

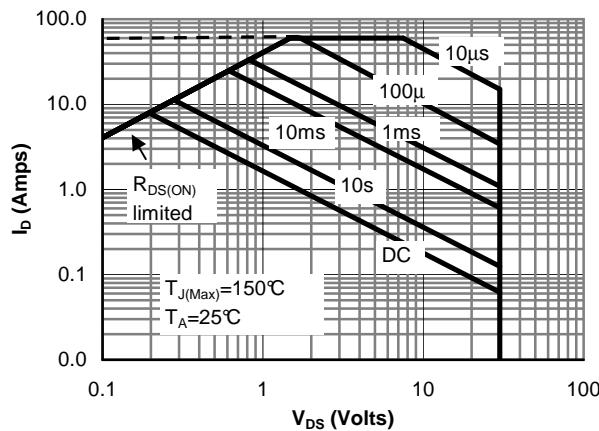


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

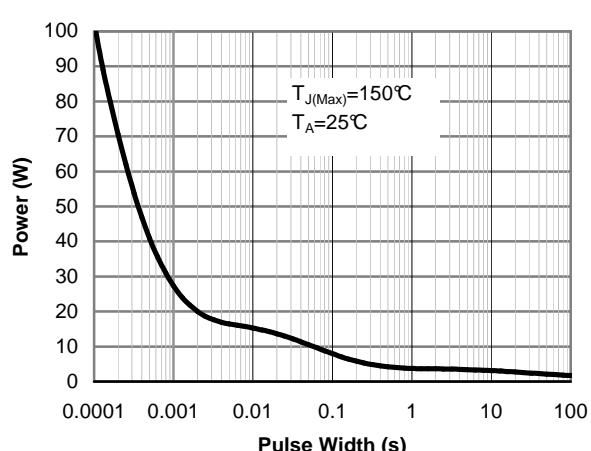


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

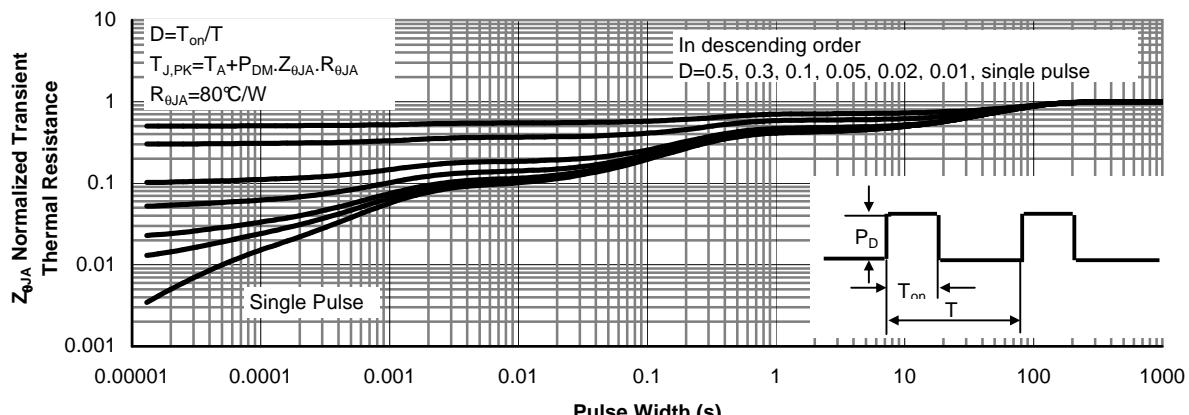


Figure 11: Normalized Maximum Transient Thermal Impedance (Note E)

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